Dual 4-bit binary ripple counter Rev. 4 — 16 May 2013

Product data sheet

1. **General description**

The 74HC393; 7474HCT393 is a dual 4-stage binary ripple counter. Each counter features a clock input (nCP), an overriding asynchronous master reset input (nMR) and 4 buffered parallel outputs (nQ0 to nQ3). The counter advances on the HIGH-to-LOW transition of $n\overline{CP}$. A HIGH on nMR clears the counter stages and forces the outputs LOW, independent of the state of nCP. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

2. **Features and benefits**

- Input levels:
 - For 74HC393: CMOS level
 - For 74HCT393: TTL level
- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V.
- Two 4-bit binary counters with individual clocks
- Divide by any binary module up to 28 in one package
- Two master resets to clear each 4-bit counter individually

Ordering information 3.

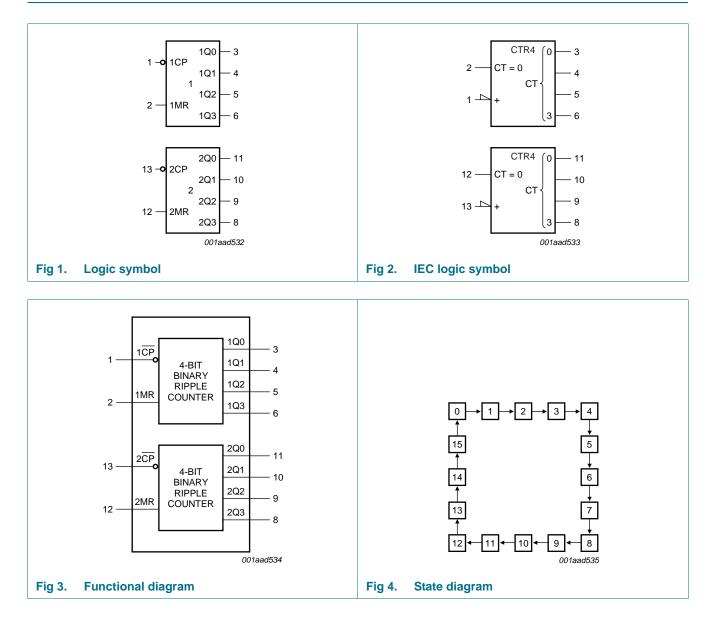
Table 1. **Ordering information**

Type number	Package			
	Temperature range	Name	Description	Version
74HC393N	–40 °C to +125 °C	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1
74HCT393N				
74HC393D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74HCT393D				
74HC393DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width	SOT337-1
74HCT393DB			5.3 mm	
74HC393PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body	SOT402-1
74HCT393PW			width 4.4 mm	
74HC393BQ	–40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin	SOT762-1
74HCT393BQ			quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm	



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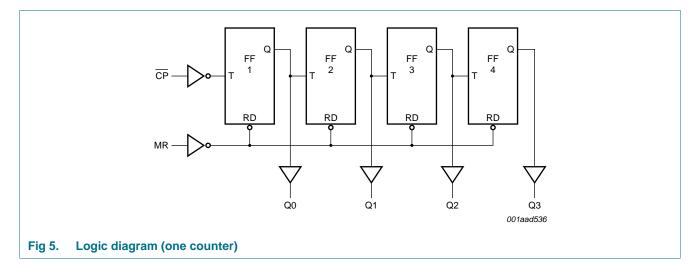
4. Functional diagram



NXP Semiconductors

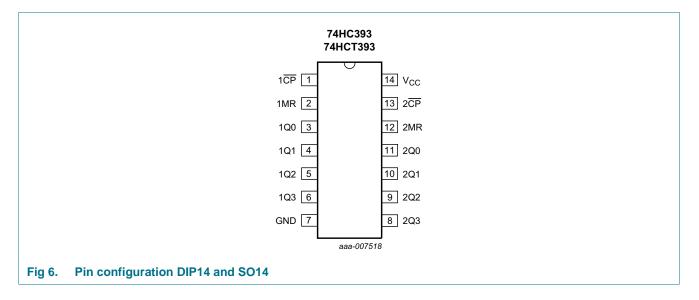
74HC393; 74HCT393

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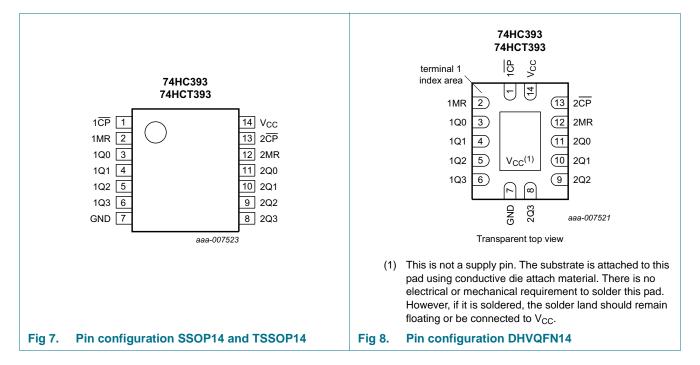


5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1CP	1	clock input (HIGH-to-LOW, edge-triggered)
1MR	2	asynchronous master reset input (active HIGH)
1Q0	3	flip-flop output
1Q1	4	flip-flop output
1Q2	5	flip-flop output
1Q3	6	flip-flop output
GND	7	ground (0 V)
2Q3	8	flip-flop output
2Q2	9	flip-flop output
2Q1	10	flip-flop output
2Q0	11	flip-flop output
2MR	12	asynchronous master reset input (active HIGH)
2CP	13	clock input (HIGH-to-LOW, edge-triggered)
V _{CC}	14	supply voltage

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6. Functional description

ount	Output			
	nQ0	nQ1	nQ2	nQ3
	L	L	L	L
	Н	L	L	L
	L	Н	L	L
	Н	Н	L	L
	L	L	Н	L
	Н	L	Н	L
	L	Н	Н	L
	Н	Н	Н	L
	L	L	L	Н
	Н	L	L	Н
	L	Н	L	Н
	Н	Н	L	Н
	L	L	Н	Н
	Н	L	Н	Н
	L	Н	Н	Н
	Н	Н	Н	Н

[1] H = HIGH voltage level; L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

				10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
lo	output current	$V_{\rm O}$ = –0.5 V to V_{\rm CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	±50	mA
I _{GND}	ground current		-	±50	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	DIP14 package	<u>[1]</u> _	750	mW
		SO14, SSOP14, TSSOP14 and DHVQFN14 package	[2] _	500	mW

[1] For DIP14 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	-	74HC393	3	7	4HCT39	3	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC39	3									
V _{IH}	HIGH-level	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	-	1.8	V
V _{OH}	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL}$								
		I_{O} = -20 μ A; V_{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I_{O} = –20 $\mu\text{A};V_{CC}$ = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I_{O} = –20 $\mu A; V_{CC}$ = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I_{O} = -4.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_I = V_{CC} \text{ or GND};$ $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±0.1	-	±0.1	μΑ
I _{CC}	supply current		-	-	8.0	-	80	-	160	μΑ

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Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
CI	input capacitance		-	3.5	-			· · · ·		pF
74HCT3	93									
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	V_{I} = V_{IH} or $V_{\text{IL}};$ V_{CC} = 4.5 V								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -6 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I _O = 6.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC} \text{ or GND};$ $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{CC}	supply current		-	-	8.0	-	80	-	160	μA
Δl _{CC}	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 2.1 \text{ V};\\ \text{other inputs at } V_{CC} \text{ or GND};\\ V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}; \text{ I}_{O} = 0 \text{ A} \end{array}$								
		per input pin; nCP	-	40	144	-	180	-	196	μA
		per input pin; nMR	-	100	360	-	450	-	490	μA
CI	input capacitance		-	3.5	-					pF

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Dual 4-bit binary ripple counter

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 11.

Symbol	Parameter	Conditions			25 °C		_40 °C	to +85 °C	−40 °C	to +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
74HC393	3							·			
t _{pd}	propagation	nCP to nQ0; see Figure 9	[1]								
	delay	$V_{CC} = 2.0 V$		-	41	125	-	155	-	190	ns
		$V_{CC} = 4.5 V$		-	15	25	-	31	-	38	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	12	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	12	21	-	26	-	32	ns
		nQx to nQ(x+1); see <mark>Figure 9</mark>	[1]								
		$V_{CC} = 2.0 V$		-	14	45	-	55	-	70	ns
		$V_{CC} = 4.5 V$		-	5	9	-	11	-	14	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	5	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	4	8	-	9	-	12	ns
PHL	HIGH to	nMR to nQx; see Figure 10									
	LOW propagation delay	$V_{CC} = 2.0 V$		-	39	140	-	175	-	210	ns
		$V_{CC} = 4.5 V$		-	14	28	-	35	-	42	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	11	-	-	-	-	-	ns
		$V_{CC} = 6.0 V$		-	11	24	-	30	-	36	ns
t	transition	Qn; see Figure 9	[2]								
	time	$V_{CC} = 2.0 V$		-	19	75	-	95	-	110	ns
		$V_{CC} = 4.5 V$		-	7	15	-	19	-	22	ns
		$V_{CC} = 6.0 V$		-	6	13	-	16	-	19	ns
tw	pulse width	n <mark>CP</mark> HIGH or LOW; see <u>Figure 9</u>									
		$V_{CC} = 2.0 V$		80	17	-	100	-	120	-	ns
		$V_{CC} = 4.5 V$		16	6	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$		14	5	-	17	-	20	-	ns
		nMR HIGH; see Figure 10									
		$V_{CC} = 2.0 V$		80	19	-	100	-	120	-	ns
		$V_{CC} = 4.5 V$		16	7	-	20	-	24	-	ns
		$V_{CC} = 6.0 V$		14	6	-	17	-	20	-	ns
rec	recovery	nMR to nCP; see Figure 10									
	time	$V_{CC} = 2.0 V$		5	3	-	5	-	5	-	ns
		$V_{CC} = 4.5 V$		5	1	-	5	-	5	-	ns
		$V_{CC} = 6.0 V$		5	1	-	5	-	5	-	ns

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Symbol	Parameter	Conditions			25 °C		–40 °C	to +85 °C	-40 °C	to +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
f _{clk(max)}	maximum	see Figure 9									•
	clock frequency	$V_{CC} = 2.0 V$		6	30	-	5	-	4	-	MHz
	nequency	$V_{CC} = 4.5 V$		30	90	-	24	-	20	-	MHz
		$V_{CC} = 5 V; C_L = 15 pF$		-	99	-	-	-	-	-	MHz
		$V_{CC} = 6.0 V$		35	107	-	28		24	-	MHz
C _{PD}	power dissipation capacitance	C_L = 50 pF; f = 1 MHz; V _I = GND to V _{CC}	<u>[3]</u>	-	23	-	-	-	-	-	pF
74HCT3	93										
t _{pd}	propagation	nCP to nQ0; see Figure 9	[1]								
	delay	$V_{CC} = 4.5 V$		-	15	25	-	31	-	38	ns
		$V_{CC} = 5 V; C_L = 15 pF$		-	20	-	-	-	-	-	ns
		nQx to nQ(x+1); see <u>Figure 9</u>	<u>[1]</u>								
		$V_{CC} = 4.5 V$		-	6	10	-	13	-	15	ns
		$V_{CC} = 5 V; C_{L} = 15 pF$		-	6	-	-	-	-	-	ns
t _{PHL}	HIGH to	nMR to nQx; see Figure 10									
	LOW propagation	$V_{CC} = 4.5 V$		-	18	32	-	40	-	48	ns
	delay	$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	15	-	-	-	-	-	ns
t _t	transition	Qn; see Figure 9	[2]								
	time	$V_{CC} = 4.5 V$		-	7	15	-	19	-	22	ns
t _W	pulse width	n <mark>CP</mark> HIGH or LOW; see <u>Figure 9</u>									
		$V_{CC} = 4.5 V$		19	11	-	24	-	29	-	ns
		nMR HIGH; see Figure 10									
		$V_{CC} = 4.5 V$		16	6	-	20	-	24	-	ns
t _{rec}	recovery time	nMR to n CP ; see <u>Figure 10</u>									
		$V_{CC} = 4.5 V$		5	0	-	5	-	5	-	ns
f _{clk(max)}	maximum	see Figure 9									
	clock	$V_{CC} = 4.5 V$		27	48	-	22	-	18	-	MHz
	frequency	$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	53	-	-	-	-	-	MHz

Table 7. Dynamic characteristics ... continued

Dual 4-bit binary ripple counter

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see <u>Figure 11</u> .										
Symbol	Parameter	Conditions		25 °C		–40 °C to +85 °C		–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Мах	
C _{PD}	power dissipation capacitance	$C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$	-	25	-	-	-	-	-	pF

Table 7. Dynamic characteristics ...continued

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

10.1 Waveforms

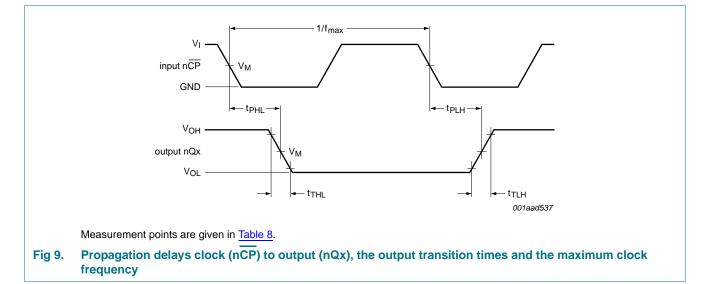


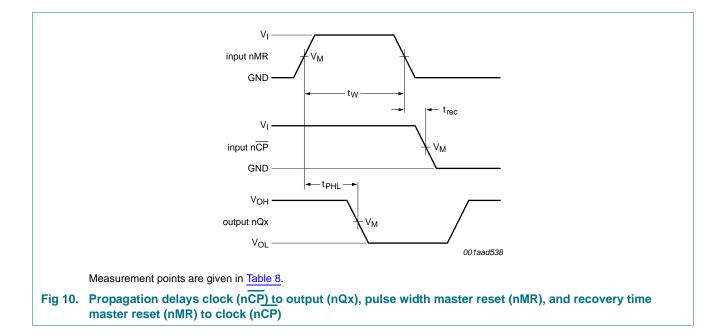
Table 8.Measurement points

Туре	Input	Output
	V _M	V _M
74HC393	0.5V _{CC}	0.5V _{CC}
74HCT393	1.3 V	1.3 V

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74HC393; 74HCT393

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NXP Semiconductors

74HC393; 74HCT393

Dual 4-bit binary ripple counter

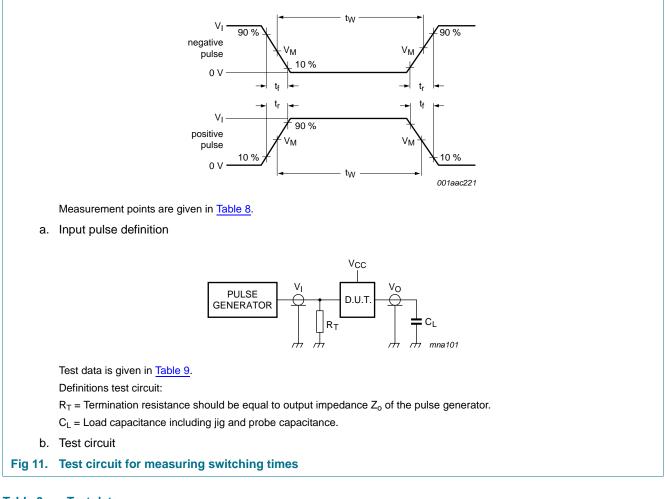


Table 9. Test	data
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Туре	Input		Load
	VI	t _r , t _f	CL
74HC393	V _{CC}	6 ns	15 pF, 50 pF
74HCT393	3 V	6 ns	15 pF, 50 pF

Dual 4-bit binary ripple counter

11. Package outline

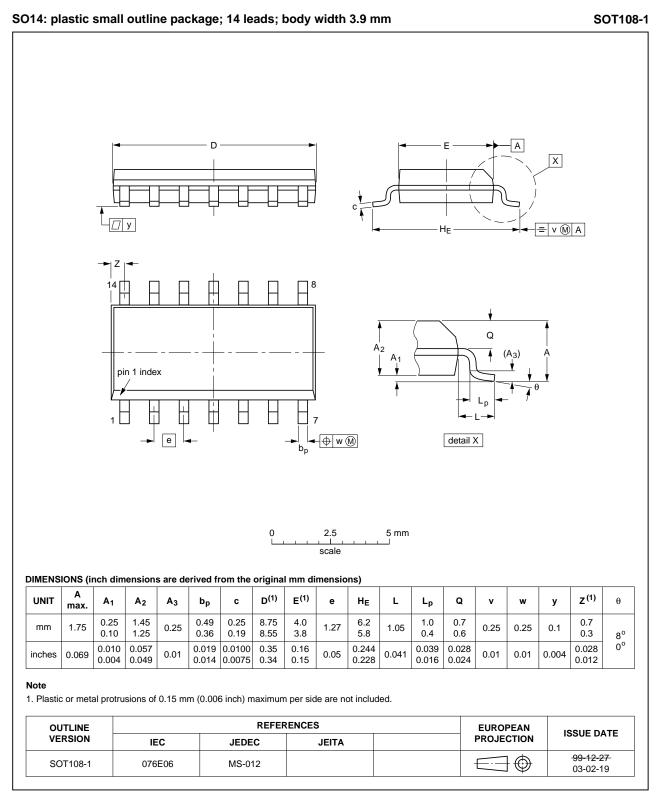
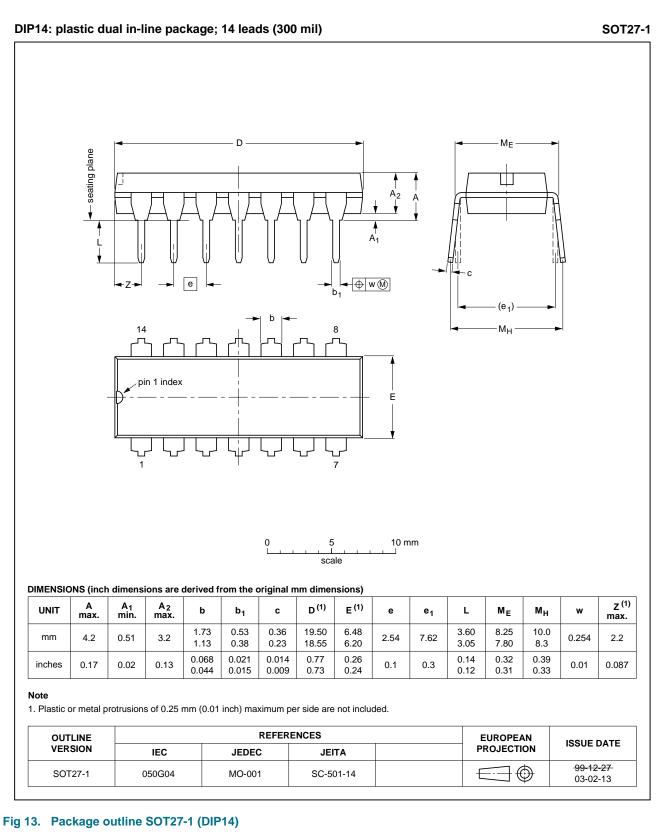


Fig 12. Package outline SOT108-1 (SO14)

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Dual 4-bit binary ripple counter



74HC_HCT393 Product data sheet

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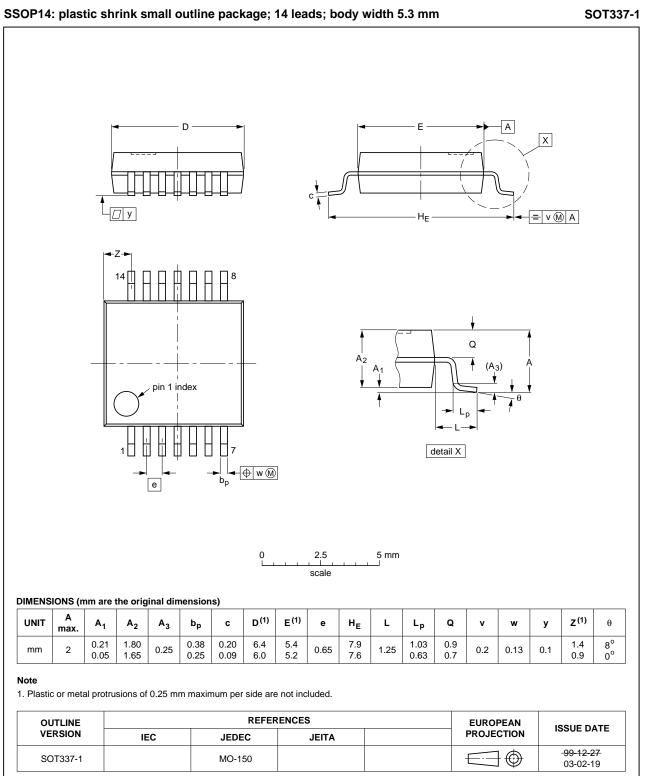


Fig 14. Package outline SOT337-1 (SSOP14)

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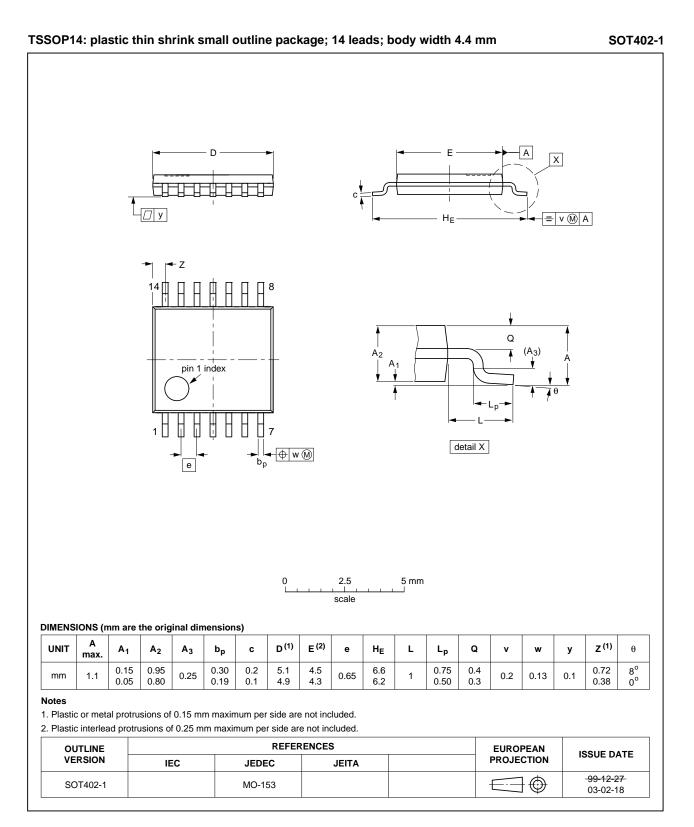
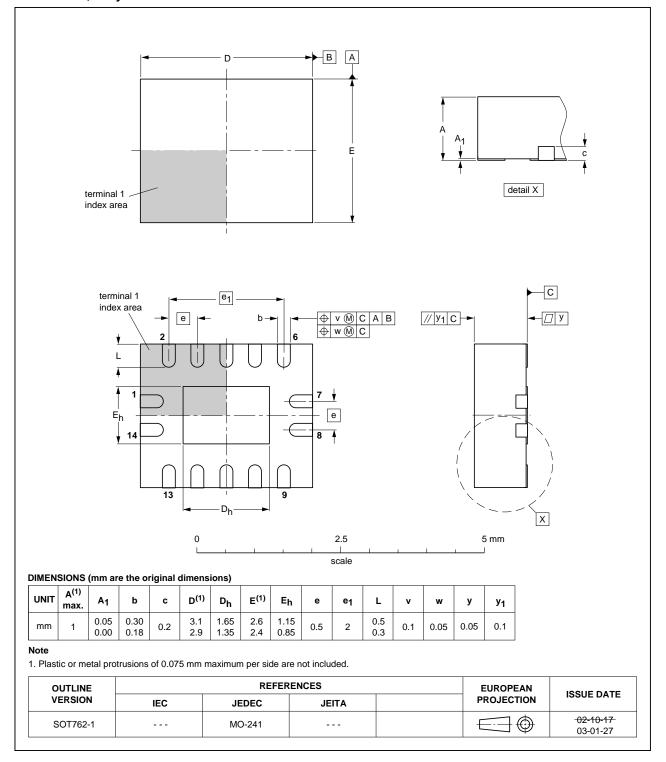


Fig 15. Package outline SOT402-1 (TSSOP14)

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Dual 4-bit binary ripple counter



DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 16. Package outline SOT762-1 (DHVQFN14)

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12. Abbreviations

Table 10. Abbreviations table				
Acronym	Description			
CMOS	Complementary Metal Oxide Semiconductor			
TTL	Transistor-Transistor Logic			
LSTTL	Low-power Schottky Transistor-Transistor Logic			
DUT	Device Under Test			

13. Revision history

Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT393 v.4	20130516	Product data sheet	-	74HC_HCT393 v.3
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 			
74HC_HCT393 v.3	20050906	Product data sheet	-	74HC_HCT393_CNV v.2
74HC_HCT393_CNV v.2	19901201	Product specification	-	•

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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